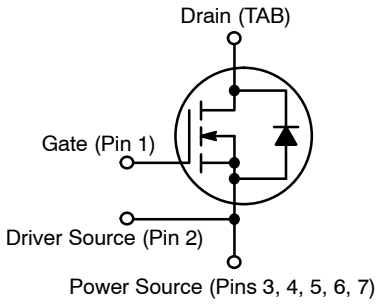
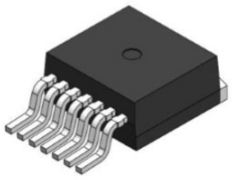
Silicon Carbide (SiC) MOSFET – EliteSiC, 12 mohm, 650 V, M2, D2PAK-7L

NTBG015N065SC1

$V_{(BR)DSS}$	$R_{DS(ON)}$ MAX	I_D MAX
650 V	18 mΩ @ 18 V	145 A



N−CHANNEL MOSFET



D2PAK−7L
CASE 418BJ

Features

- Typ. $R_{DS(on)}$ = 12 mΩ @ V_{GS} = 18 V
  Typ. $R_{DS(on)}$ = 15 mΩ @ V_{GS} = 15 V
- Ultra Low Gate Charge ($Q_{G(tot)}$ = 283 nC)
- Low Effective Output Capacitance (C_{oss} = 424 pF)
- 100% Avalanche Tested
- T_J = 175°C
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb−Free 2LI (on second level interconnection)

Typical Applications

- SMPS (Switching Mode Power Supplies)
- Solar Inverters
- UPS (Uninterruptable Power Supplies)
- Energy Storages

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain−to−Source Voltage			V_{DSS}	650	V
Gate−to−Source Voltage			V_{GS}	−8/+22	V
Recommended Operation Values of Gate − Source Voltage		T_C < 175°C	V_{GSop}	−5/+18	V
Continuous Drain Current $R_{\theta JC}$ (Note 2)	Steady State	T_C = 25°C	I_D	145	A
Power Dissipation $R_{\theta JC}$ (Note 2)			P_D	500	W
Continuous Drain Current $R_{\theta JA}$ (Notes 1, 2)	Steady State	T_C = 100°C	I_D	103	A
Power Dissipation $R_{\theta JA}$ (Notes 1, 2)			P_D	250	W
Pulsed Drain Current (Note 3)		T_C = 25°C	I_{DM}	422	A
Operating Junction and Storage Temperature Range			T_J, T_{stg}	−55 to +175	°C
Source Current (Body Diode)			I_S	111	A
Single Pulse Drain−to−Source Avalanche Energy (I_L = 13 A_{pk}, L = 1 mH) (Note 4)			E_{AS}	84	mJ
Maximum Lead Temperature for Soldering, 1/8″ from Case for 10 Seconds			T_L	245	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface mounted on a FR−4 board using1 in^2 pad of 2 oz copper.
2. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
3. Repetitive rating, limited by max junction temperature.
4. E_{AS} of 84 mJ is based on starting T_J = 25°C; L = 1 mH, I_{AS} = 13 A, V_{DD} = 50 V, V_{GS} = 18 V.

MARKING DIAGRAM



BG015N065SC1 = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping†
NTBG015N065SC1	D2PAK−7L	800 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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THERMAL CHARACTERISTICS

Parameter	Symbol	Max	Unit
Thermal Resistance Junction−to−Case (Note 2)	$R_{\theta JC}$	0.3	°C/W
Thermal Resistance Junction−to−Ambient (Notes 1, 2)	$R_{\theta JA}$	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise stated)

Parameter	Symbol	Test Condition		Min	Typ	Max	Unit
OFF CHARACTERISTICS							
Drain−to−Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0 V, I_D = 1 mA		650			V
Drain−to−Source Breakdown Voltage Temperature Coefficient	$V_{(BR)DSS}/T_J$	I_D = 20 mA, refer to 25°C			0.12		V/°C
Zero Gate Voltage Drain Current	I_{DSS}	V_{GS} = 0 V, V_{DS} = 650 V	T_J = 25°C			10	μA
			T_J = 175°C			1	mA
Gate−to−Source Leakage Current	I_{GSS}	V_{GS} = +22/−8 V, V_{DS} = 0 V				250	nA
ON CHARACTERISTICS							
Gate Threshold Voltage	$V_{GS(TH)}$	V_{GS} = V_{DS} , I_D = 25 mA		1.8	2.8	4.3	V
Recommended Gate Voltage	V_{GOP}			−5		+18	V
Drain−to−Source On Resistance	$R_{DS(on)}$	V_{GS} = 15 V, I_D = 75 A, T_J = 25°C			15		mΩ
		V_{GS} = 18 V, I_D = 75 A, T_J = 25°C			12	18	
		V_{GS} = 18 V, I_D = 75 A, T_J = 175°C			16		
Forward Transconductance	g_{FS}	V_{DS} = 10 V, I_D = 75 A			42		S
CHARGES, CAPACITANCES & GATE RESISTANCE							
Input Capacitance	C_{ISS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 325 V			4689		pF
Output Capacitance	C_{OSS}				424		
Reverse Transfer Capacitance	C_{RSS}				37		
Total Gate Charge	$Q_{G(TOT)}$	V_{GS} = −5/18 V, V_{DS} = 520 V, I_D = 75 A			283		nC
Gate−to−Source Charge	Q_{GS}				72		
Gate−to−Drain Charge	Q_{GD}				64		
Gate−Resistance	R_G	f = 1 MHz			1.6		Ω
SWITCHING CHARACTERISTICS							
Turn−On Delay Time	$t_{d(ON)}$	V_{GS} = −5/18 V, V_{DS} = 400 V, I_D = 75 A, R_G = 2.2 Ω, Inductive Load			23		ns
Rise Time	t_r				26		
Turn−Off Delay Time	$t_{d(OFF)}$				49		
Fall Time	t_f				9.6		
Turn−On Switching Loss	E_{ON}				167		μJ
Turn−Off Switching Loss	E_{OFF}				276		
Total Switching Loss	E_{TOT}				443		
DRAIN−SOURCE DIODE CHARACTERISTICS							
Continuous Drain−Source Diode Forward Current	I_{SD}	V_{GS} = −5 V, T_J = 25°C				111	A
Pulsed Drain−Source Diode Forward Current (Note 3)	I_{SDM}	V_{GS} = −5 V, T_J = 25°C				422	A
Forward Diode Voltage	V_{SD}	V_{GS} = −5 V, I_{SD} = 75 A, T_J = 25°C			4.8		V

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ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise stated)(continued)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
DRAIN−SOURCE DIODE CHARACTERISTICS						
Reverse Recovery Time	t_{RR}	V_{GS} = −5/18 V, I_{SD} = 75 A, dI_S/dt = 1000 A/μs		28		ns
Reverse Recovery Charge	Q_{RR}			234		nC
Reverse Recovery Energy	E_{REC}			23		μJ
Peak Reverse Recovery Current	I_{RRM}			16		A
Charge Time	Ta			17		ns
Discharge Time	Tb			11		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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TYPICAL CHARACTERISTICS

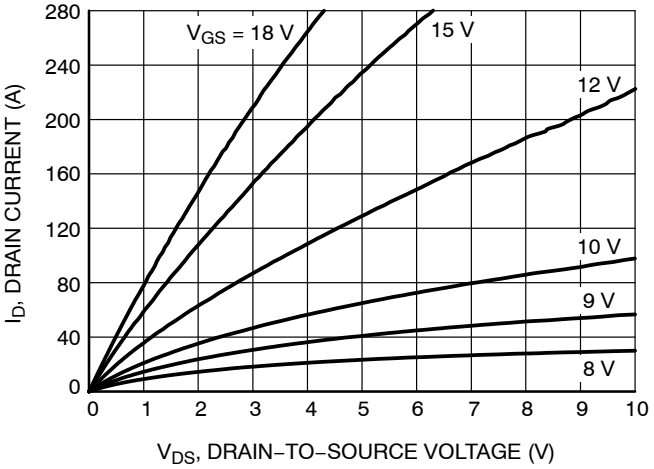


Figure 1. On−Region Characteristics

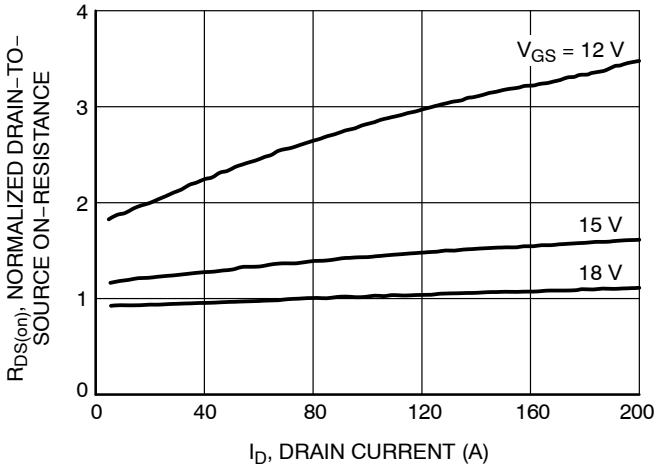


Figure 2. Normalized On−Resistance vs. Drain Current and Gate Voltage

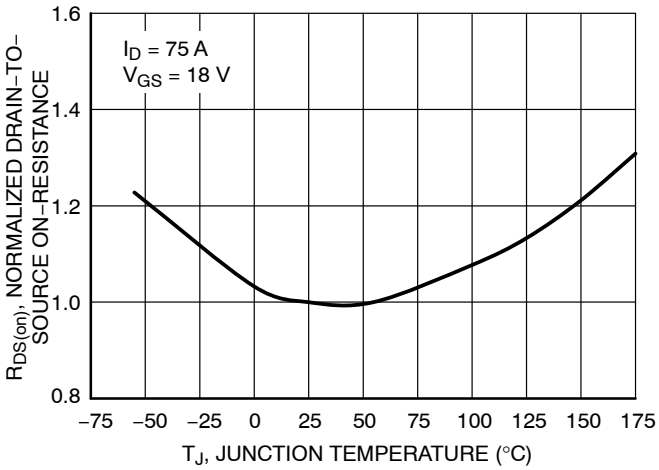


Figure 3. On−Resistance Variation with Temperature

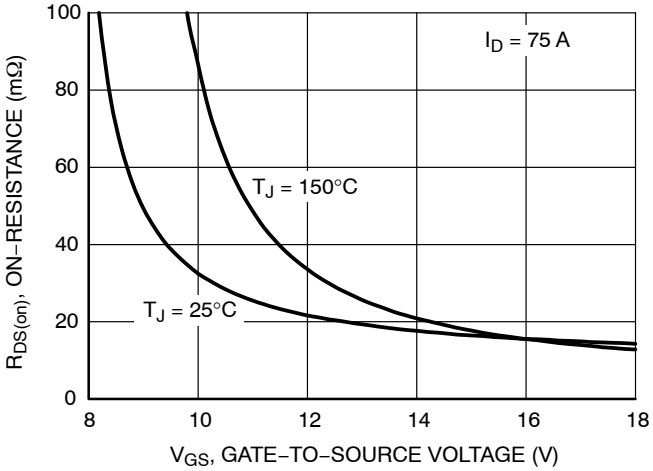


Figure 4. On−Resistance vs. Gate−to−Source Voltage

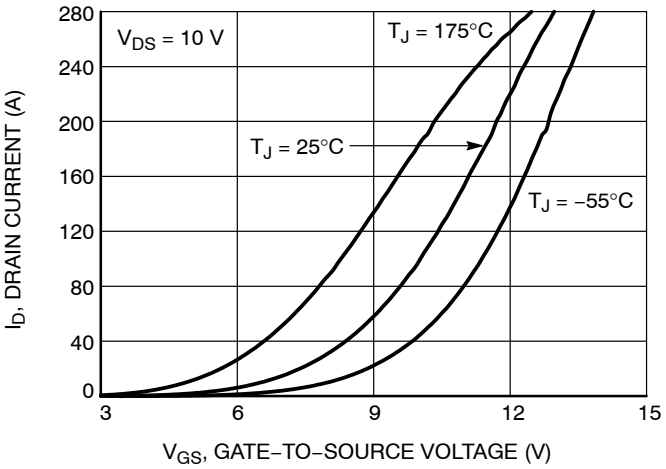


Figure 5. Transfer Characteristics

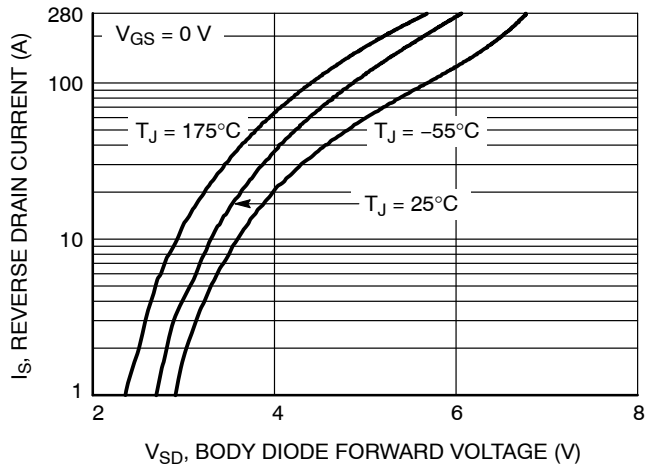


Figure 6. Diode Forward Voltage vs. Current

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TYPICAL CHARACTERISTICS (continued)

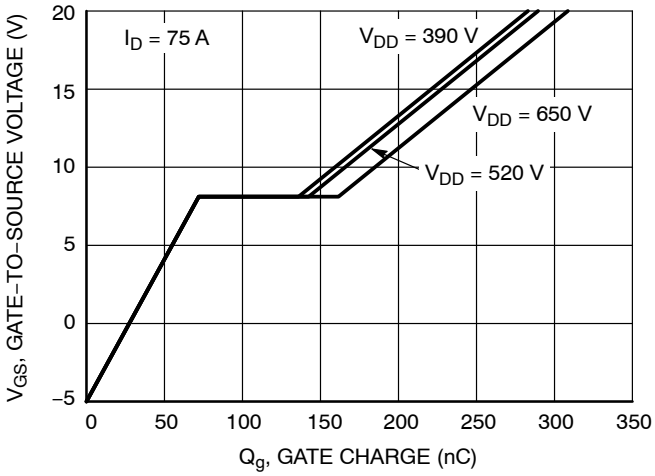


Figure 7. Gate−to−Source Voltage vs. Total Charge

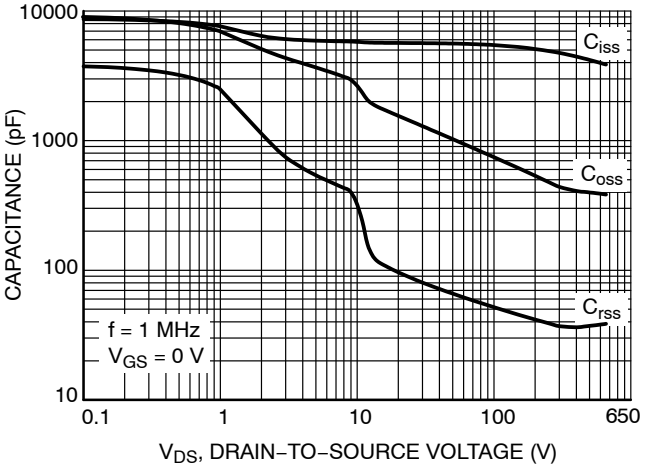


Figure 8. Capacitance vs. Drain−to−Source Voltage

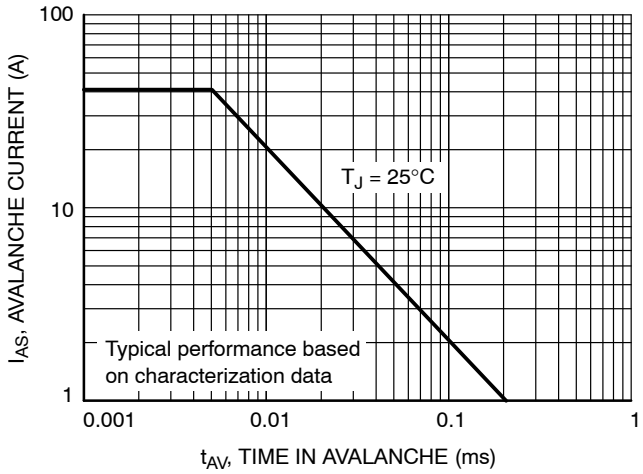


Figure 9. Unclamped Inductive Switching Capability

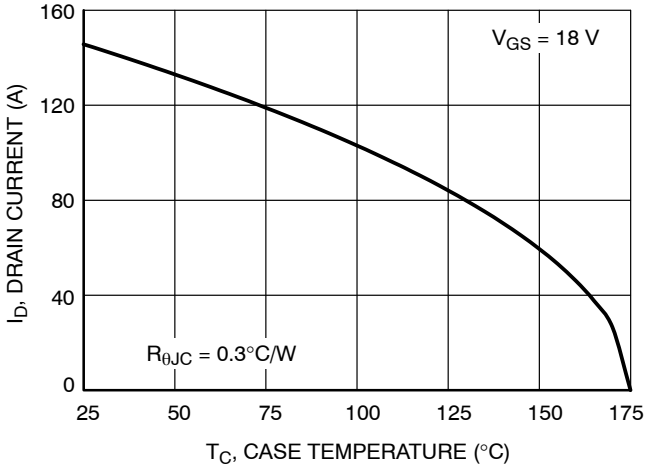


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

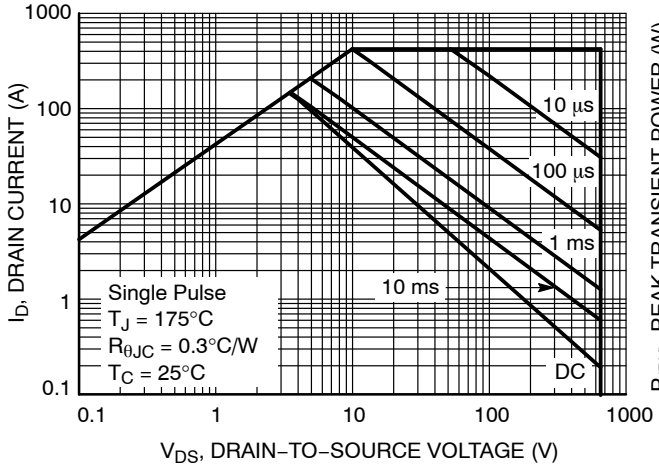


Figure 11. Safe Operating Area

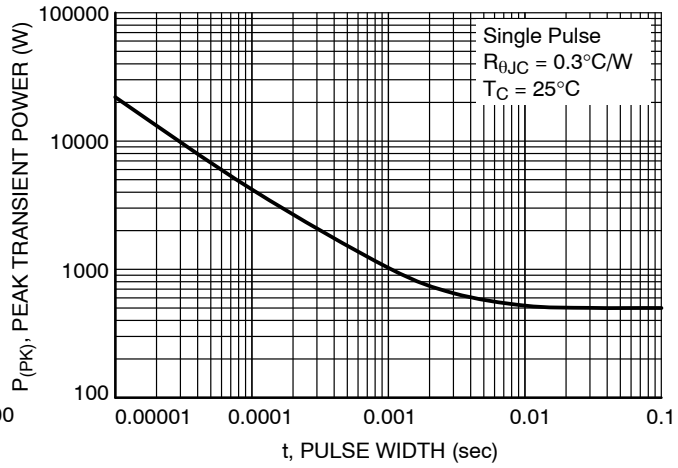


Figure 12. Single Pulse Maximum Power Dissipation

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TYPICAL CHARACTERISTICS (continued)

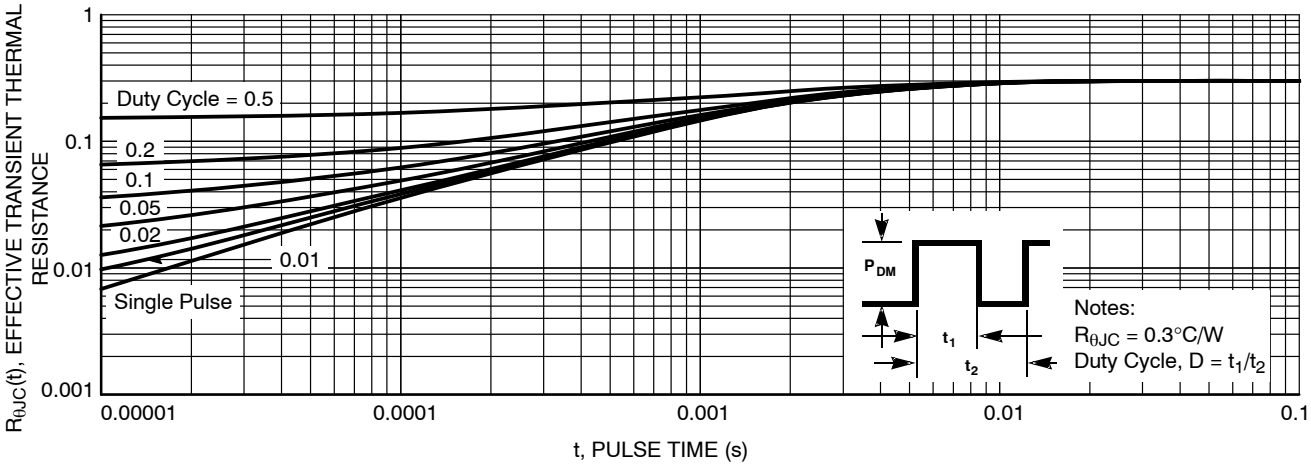
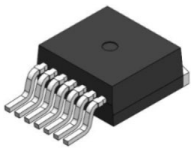


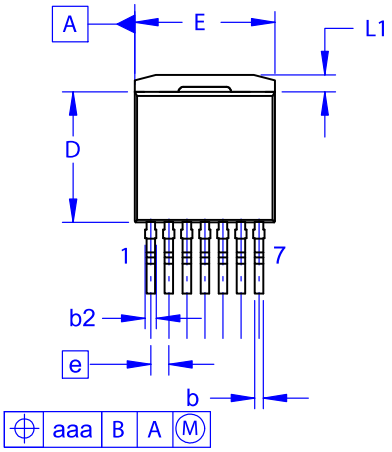
Figure 13. Junction−to−Case Transient Thermal Response Curve

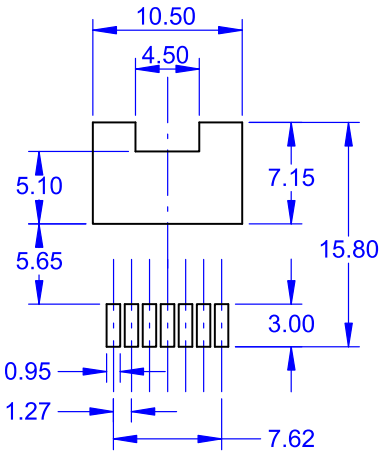
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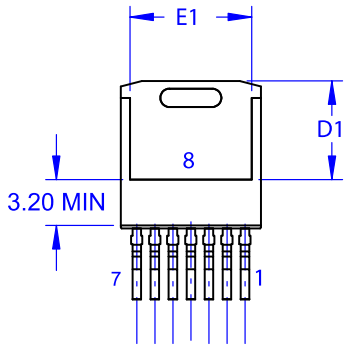
D²PAK7 (TO−263−7L HV)
CASE 418BJ
ISSUE B

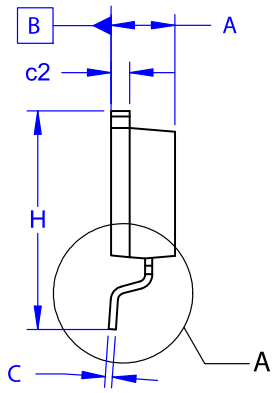
DATE 16 AUG 2019





LAND PATTERN RECOMMENDATION





NOTES:

A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED.
B. ALL DIMENSIONS ARE IN MILLIMETERS.
C OUT OF JEDEC STANDARD VALUE.
D. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.
E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.

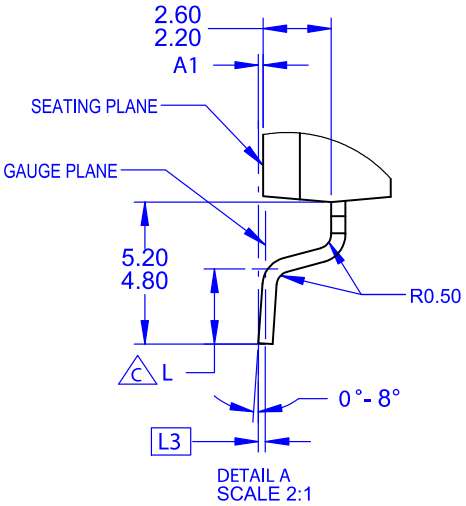
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	MIN	NOM	MAX
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A1	0.00	0.10	0.20
b2	0.60	0.70	0.80
b	0.51	0.60	0.70
c	0.40	0.50	0.60
c2	1.20	1.30	1.40
D	9.00	9.20	9.40
D1	6.15	6.80	7.15
E	9.70	9.90	10.20
E1	7.15	7.65	8.15
e	~	1.27	~
H	15.10	15.40	15.70
L	2.44	2.64	2.84
L1	1.00	1.20	1.40
L3	~	0.25	~
aaa	~	~	0.25

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.



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Üretici parça numarasını yazın; stok ve fiyatı hemen görün.

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Üreticileri görün

Toplu alım ve teklif

Listede olmayan ya da yüksek adetli parçalar için teklif isteyin.

Teklif isteyin

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